

CR08AS-12

Thyristor

Low Power Use

REJ03G0349-0400

Rev.4.00

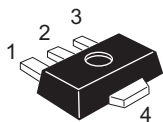
Dec 10, 2008

Features

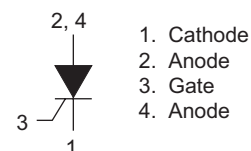
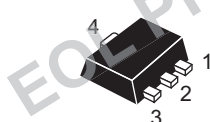
- $I_{T(AV)}$: 0.8 A
- V_{DRM} : 600 V
- I_{GT} : 100 μ A
- Non-Insulated Type
- Glass Passivation Type
- Completed Pb Free

Outline

RENESAS Package code: PLZZ0004CA-A
(Package name: UPAK)



RENESAS Package code: PLZZ0004CB-A
(Package name: SOT-89)



Applications

Solid state relay, strobe flasher, igniter, and hybrid IC

Maximum Ratings

Parameter	Symbol	Voltage class	Unit
		12 (Mark AF)	
Repetitive peak reverse voltage	V_{RRM}	600	V
Non-repetitive peak reverse voltage	V_{RSM}	720	V
DC reverse voltage	$V_{R(DC)}$	480	V
Repetitive peak off-state voltage ^{Note1}	V_{DRM}	600	V
DC off-state voltage ^{Note1}	$V_{D(DC)}$	480	V

Parameter	Symbol	Ratings	Unit	Conditions
RMS on-state current	$I_{T(RMS)}$	1.26	A	
Average on-state current	$I_{T(AV)}$	0.8	A	Commercial frequency, sine half wave 180° conduction, $T_a = 51^\circ\text{C}$ ^{Note2}
Surge on-state current	I_{TSM}	10	A	60Hz sine half wave 1 full cycle, peak value, non-repetitive
I^2t for fusing	I^2t	0.42	A^2s	Value corresponding to 1 cycle of half wave 60Hz, surge on-state current
Peak gate power dissipation	P_{GM}	0.5	W	
Average gate power dissipation	$P_{G(AV)}$	0.1	W	
Peak gate forward voltage	V_{FGM}	6	V	
Peak gate reverse voltage	V_{RGM}	6	V	
Peak gate forward current	I_{FGM}	0.3	A	
Junction temperature	T_j	- 40 to +125	°C	
Storage temperature	T_{stg}	- 40 to +125	°C	
Mass	—	50	mg	Typical value

Notes: 1. With gate to cathode resistance $R_{GK} = 1\text{ k}\Omega$.

Electrical Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test conditions
Repetitive peak reverse current	I_{RRM}	—	—	0.5	mA	$T_j = 125^\circ\text{C}$, V_{RRM} applied, $R_{GK} = 1\text{ k}\Omega$
Repetitive peak off-state current	I_{DRM}	—	—	0.5	mA	$T_j = 125^\circ\text{C}$, V_{DRM} applied, $R_{GK} = 1\text{ k}\Omega$
On-state voltage	V_{TM}	—	—	1.5	V	$T_a = 25^\circ\text{C}$, $I_{TM} = 2.5\text{ A}$, instantaneous value
Gate trigger voltage	V_{GT}	—	—	0.8	V	$T_j = 25^\circ\text{C}$, $V_D = 6\text{ V}$, $I_T = 0.1\text{ A}$ ^{Note4}
Gate non-trigger voltage	V_{GD}	0.2	—	—	V	$T_j = 125^\circ\text{C}$, $V_D = 1/2 V_{DRM}$, $R_{GK} = 1\text{ k}\Omega$
Gate trigger current	I_{GT}	20	—	100 ^{Note3}	μA	$T_j = 25^\circ\text{C}$, $V_D = 6\text{ V}$, $I_T = 0.1\text{ A}$ ^{Note4}
Holding current	I_H	—	1.5	3	mA	$T_j = 25^\circ\text{C}$, $V_D = 12\text{ V}$, $R_{GK} = 1\text{ k}\Omega$
Thermal resistance	$R_{th(j-a)}$	—	—	65	°C/W	Junction to ambient ^{Note2}

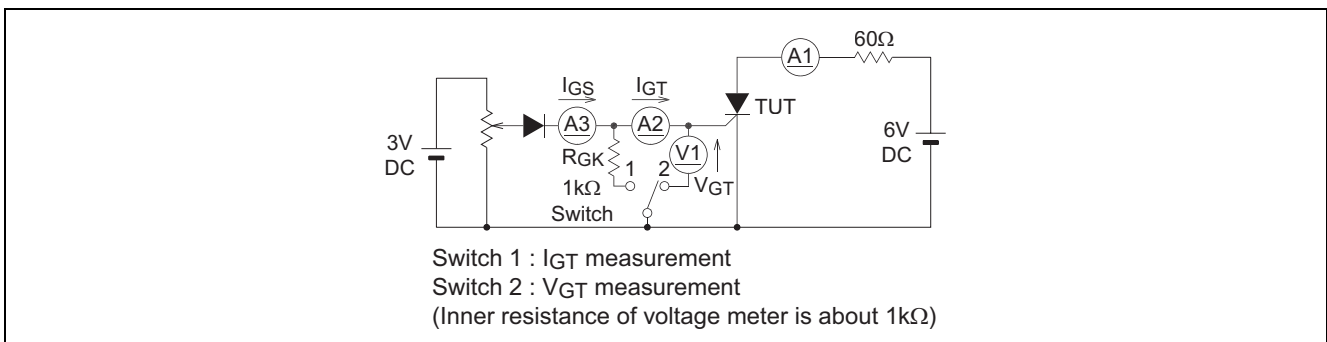
Notes: 2. Soldering with ceramic plate (25 mm × 25 mm × t0.7 mm).

3. If special values of I_{GT} are required, choose item E from those listed in the table below if possible.

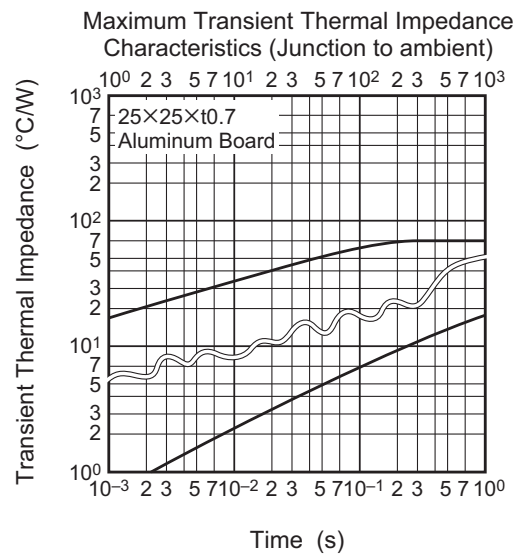
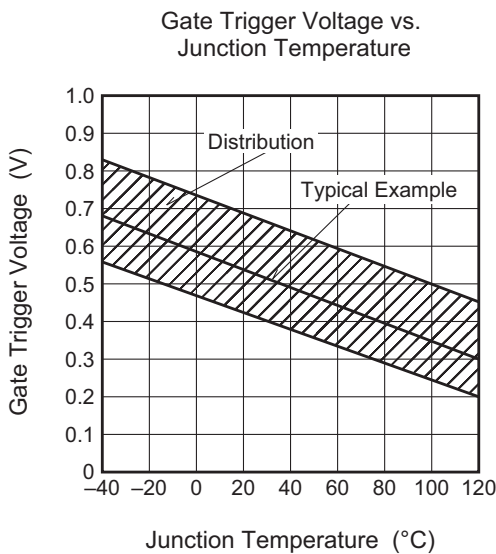
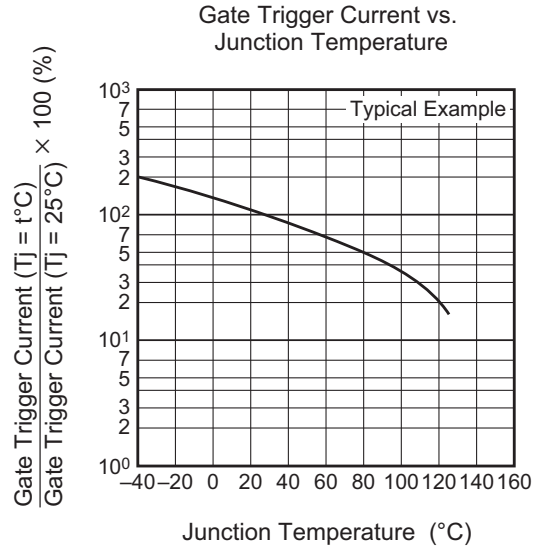
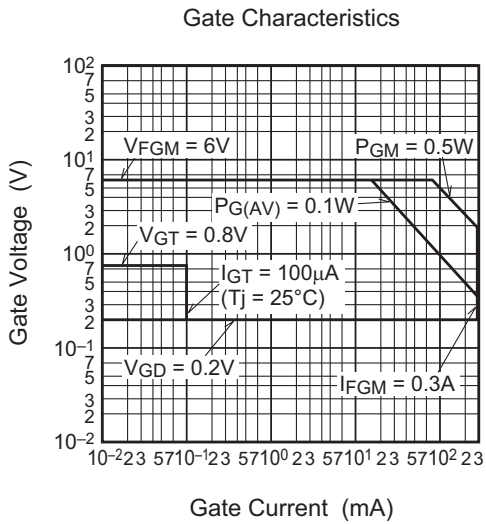
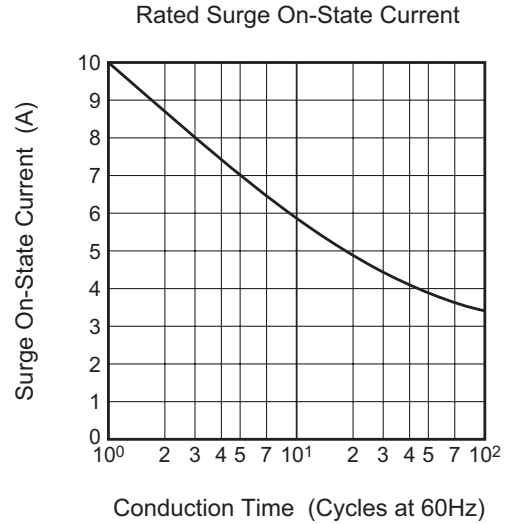
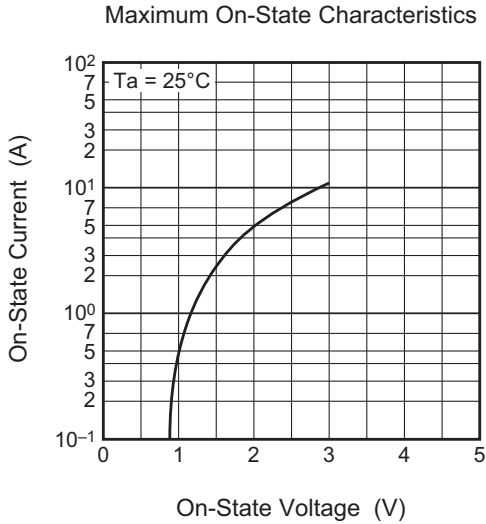
Item	B	E
$I_{GT} (\mu\text{A})$	20 to 50	20 to 100

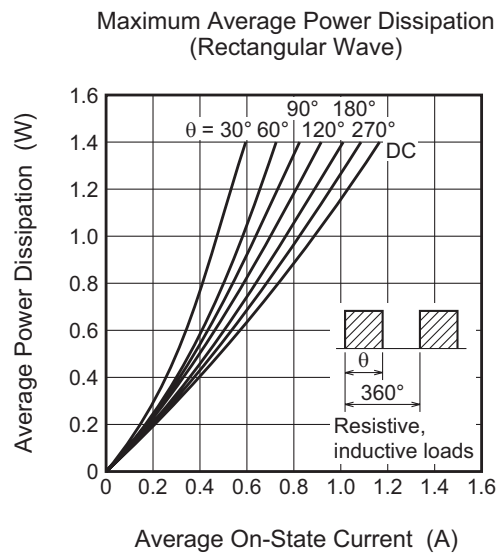
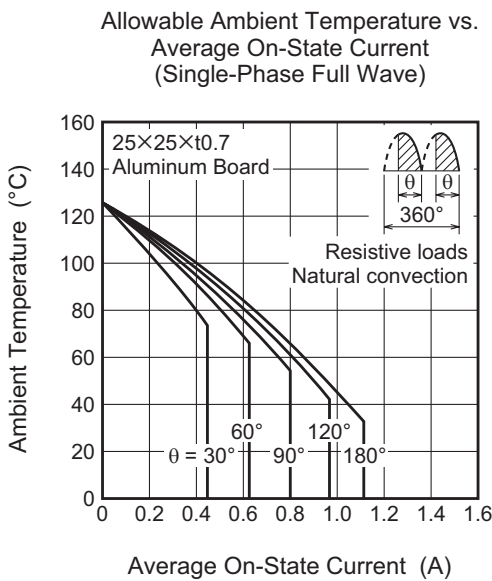
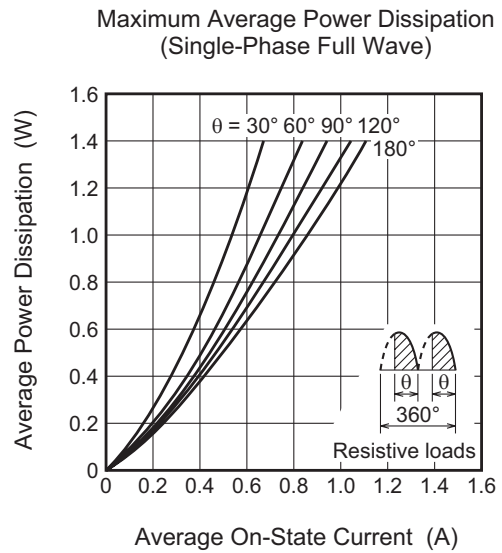
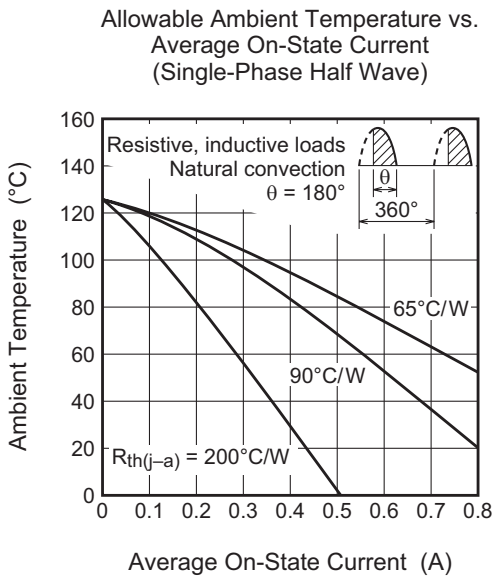
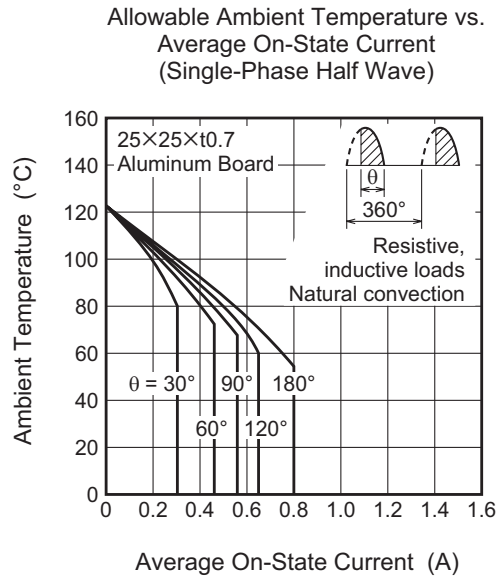
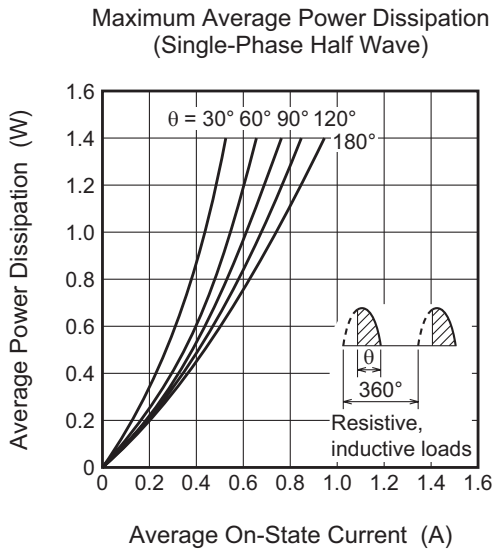
The above values do not include the current flowing through the 1 kΩ resistance between the gate and cathode.

4. I_{GT} , V_{GT} measurement circuit.

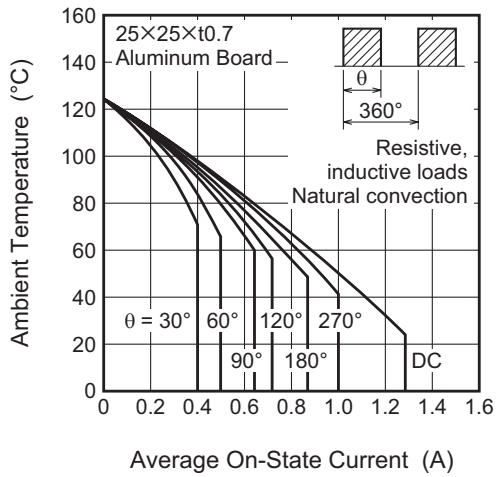


Performance Curves

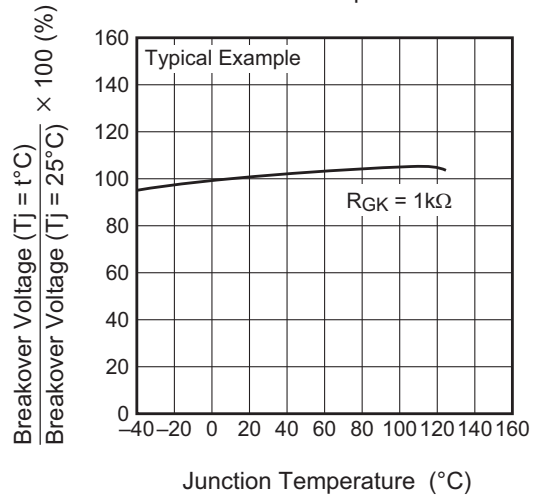




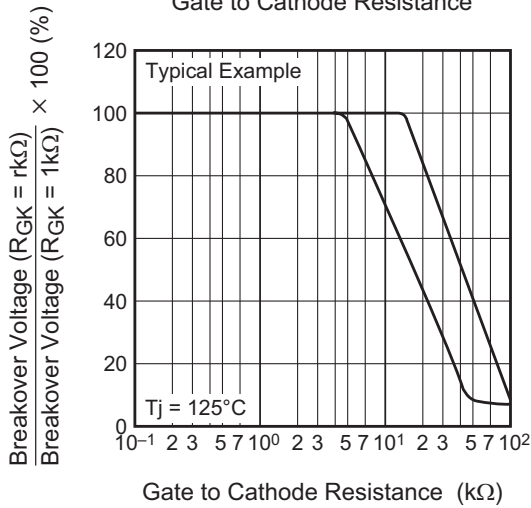
Allowable Ambient Temperature vs. Average On-State Current (Rectangular Wave)



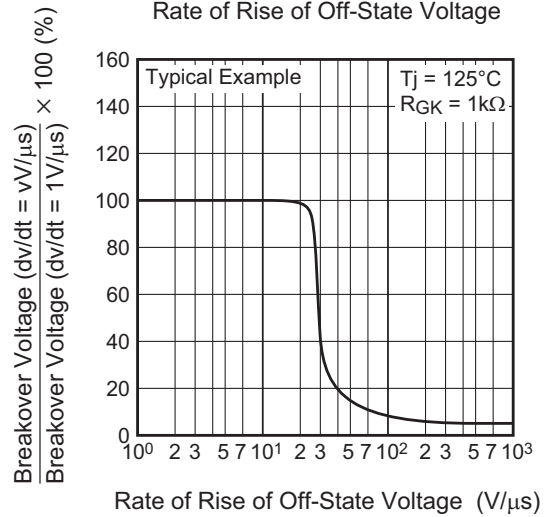
Breakover Voltage vs. Junction Temperature



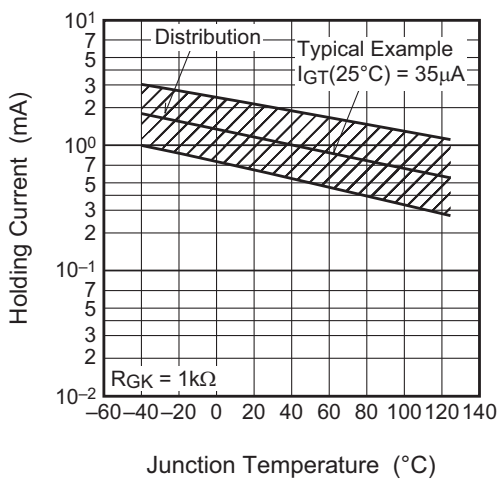
Breakover Voltage vs. Gate to Cathode Resistance



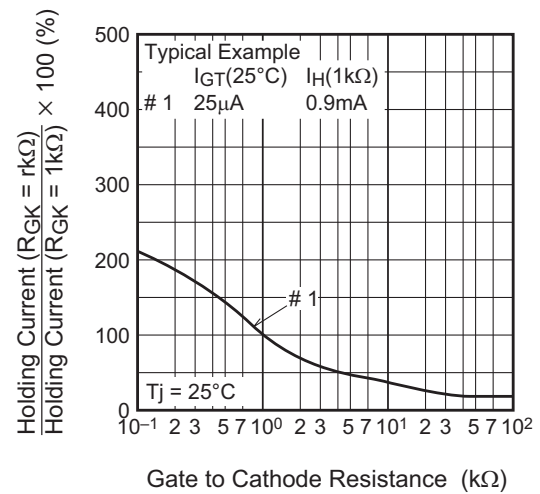
Breakover Voltage vs. Rate of Rise of Off-State Voltage



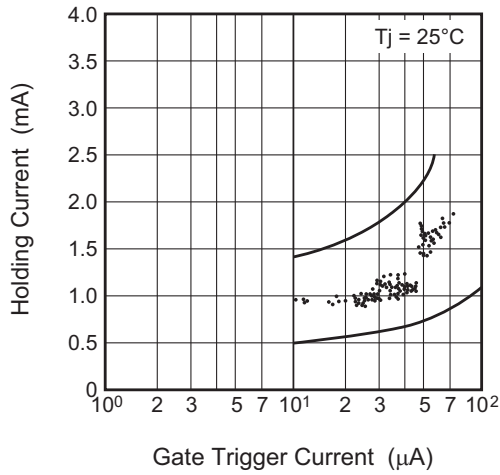
Holding Current vs. Junction Temperature



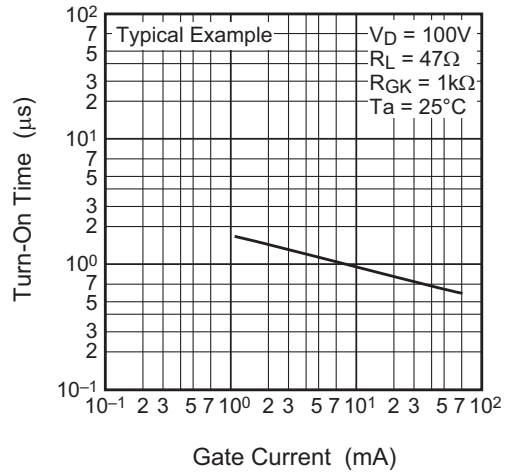
Holding Current vs. Gate to Cathode Resistance



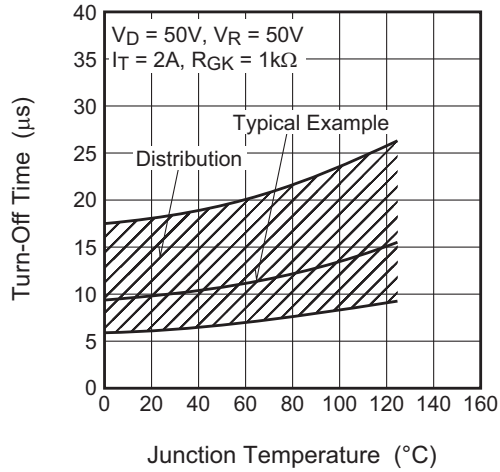
Holding Current vs. Gate Trigger Current



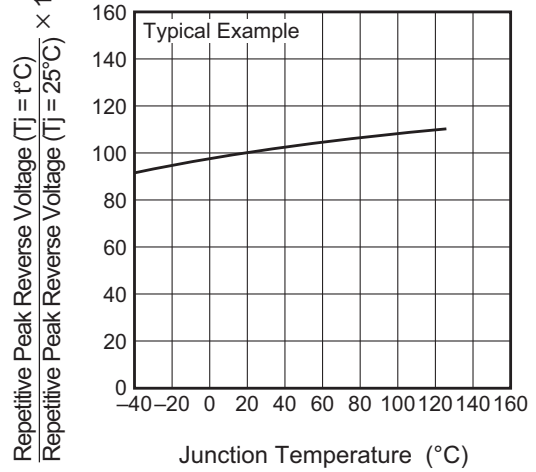
Turn-On Time vs. Gate Current



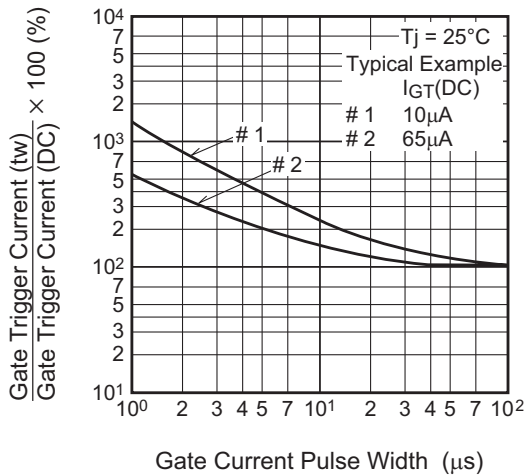
Turn-Off Time vs. Junction Temperature



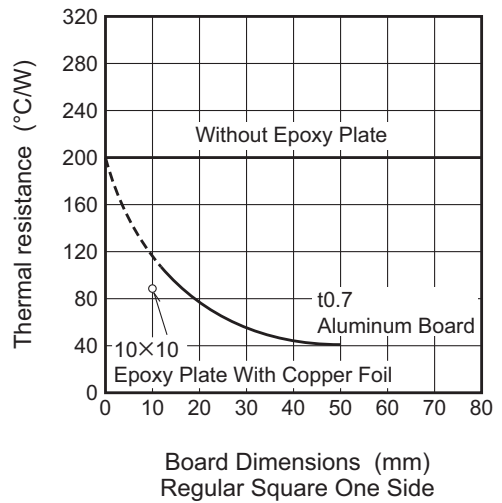
Repetitive Peak Reverse Voltage vs. Junction Temperature



Gate Trigger Current vs. Gate Current Pulse Width



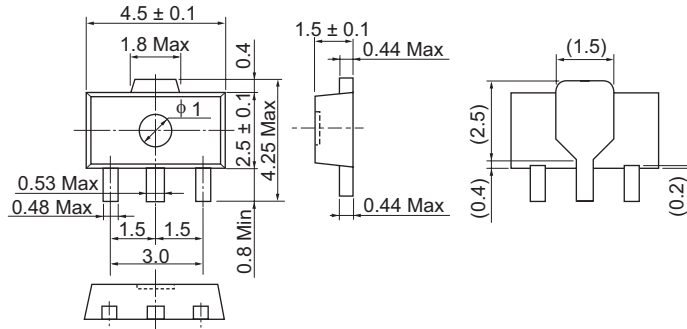
Thermal Impedance vs. Board Dimensions



Package Dimensions

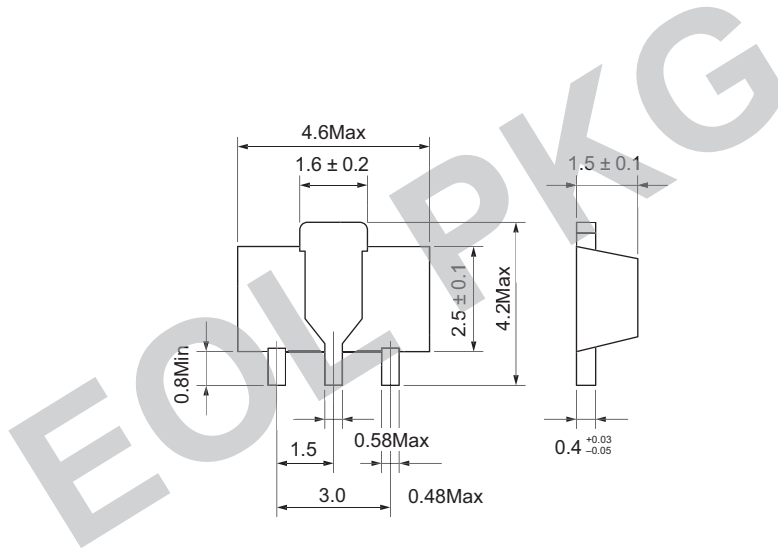
Package Name	JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
UPAK	SC-62	PLZZ0004CA-A	UPAK / UPAKV	0.050g

Unit: mm



Package Name	JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
SOT-89	SC-62	PLZZ0004CB-A	—	0.48g

Unit: mm



Order Code

Lead form	Standard packing	Quantity	Standard order code	Standard order code example
Surface-mounted type	Taping	4000	Type name – ET +Direction (1 or 2) +4	CR08AS-12-ET14

Note : Please confirm the specification about the shipping in detail.

Notes:

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